

MG1275S-BA1MM



Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E71639

Features

- Ultra Low Loss
- High Ruggedness
- High Short Circuit Capability
- Positive Temperature Coefficient
- With Fast Free-Wheeling Diodes

Applications

- Inverter
- Converter
- Welder
- SMPS and UPS
- Induction Heating

Module Characteristics ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Typ	Max	Unit
R_{thJC}	Junction-to-Case Thermal Resistance	Per IGBT			0.2	K/W
R_{thJD}		Per Inverse Diode			0.5	K/W
Torque	Module-to-Sink	Recommended (M6)	3		5	N·m
Torque	Module Electrodes	Recommended (M5)	2.5		5	N·m
Weight				150		g

Absolute Maximum Ratings ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions	Values	Unit
IGBT				
V_{CES}	Collector - Emitter Voltage		1200	V
V_{GES}	Gate - Emitter Voltage		± 20	V
I_c	DC Collector Current	$T_c = 25^\circ\text{C}$	105	A
		$T_c = 80^\circ\text{C}$	75	A
I_{Cpuls}	Pulsed Collector Current	$T_c = 25^\circ\text{C}, t_p = 1\text{ms}$	210	A
		$T_c = 80^\circ\text{C}, t_p = 1\text{ms}$	150	
P_{tot}	Power Dissipation Per IGBT		630	W
T_J	Junction Temperature Range		-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^\circ\text{C}$
V_{isol}	Insulation Test Voltage	AC, $t = 1\text{min}$	3000	V
Diode				
V_{RRM}	Repetitive Reverse Voltage		1200	V
$I_{F(AV)}$	Average Forward Current	$T_c = 25^\circ\text{C}$	90	A
		$T_c = 80^\circ\text{C}$	60	A
$I_{F(RMS)}$	RMS Forward Current		90	A
I_{FSM}	Non-Repetitive Surge Forward Current	$T_J = 45^\circ\text{C}, t = 10\text{ms}$, Sine	430	A
		$T_J = 45^\circ\text{C}, t = 8.3\text{ms}$, Sine	450	

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

MG1275S-BA1MM

Power Module

1200V 75A IGBT Module

Electrical and Thermal Specifications ($T_c = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Parameters	Test Conditions		Min	Typ	Max	Unit
IGBT							
V _{GE(th)}	Gate - Emitter Threshold Voltage	V _{CE} =V _{GE} , I _C =3mA		5.0	6.2	7.0	V
V _{CE(sat)}	Collector - Emitter Saturation Voltage	I _C =75A, V _{GE} =15V, T _J =25°C			1.8		V
		I _C =75A, V _{GE} =15V, T _J =125°C			2.0		V
I _{CES}	Collector Leakage Current	V _{CE} =1200V, V _{GE} =0V, T _J =25°C			0.2	0.5	mA
		V _{CE} =1200V, V _{GE} =0V, T _J =125°C			2		mA
I _{GES}	Gate Leakage Current	V _{CE} =0V,V _{GE} =±20V		-100		100	nA
Q _{ge}	Gate Charge	V _{CC} =600V, I _C =75A , V _{GE} =±15V			780		nC
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f =1MHz			5.52		nF
C _{oes}	Output Capacitance				0.4		
C _{res}	Reverse Transfer Capacitance				0.26		
t _{d(on)}	Turn - on Delay Time	V _{CC} =600V I _C =75A R _G =15Ω V _{GE} =±15V Inductive Load	T _J =25°C		150		ns
			T _J =125°C		160		ns
t _r	Rise Time		T _J =25°C		65		ns
			T _J =125°C		65		ns
t _{d(off)}	Turn - off Delay Time		T _J =25°C		440		ns
			T _J =125°C		500		ns
t _f	Fall Time		T _J =25°C		55		ns
			T _J =125°C		70		ns
E _{on}	Turn - on Energy		T _J =25°C		7.45		mJ
			T _J =125°C		10.3		mJ
E _{off}	Turn - off Energy		T _J =25°C		4.9		mJ
			T _J =125°C		7.8		mJ
Diode							
V _F	Forward Voltage	I _F =75A , V _{GE} =0V,T _J =25°C			2.0	2.48	V
		I _F =75A , V _{GE} =0V, T _J =125°C			1.7	2.2	V
t _{rr}	Reverse Recovery Time	I _F =75A , V _R =800V di _F /dt=-1000A/μs T _J =125°C			200		ns
I _{RRM}	Max. Reverse Recovery Current				70		A
Q _{rr}	Reverse Recovery Charge				8.2		μC

Figure 1: Typical Output Characteristics

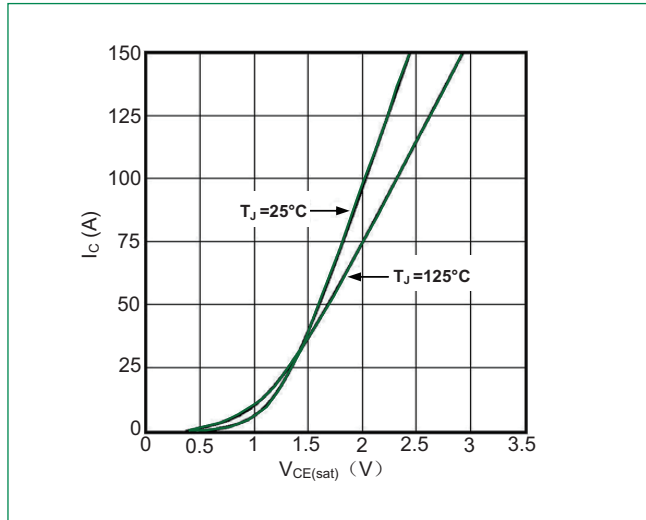


Figure 2: Typical Transfer characteristics

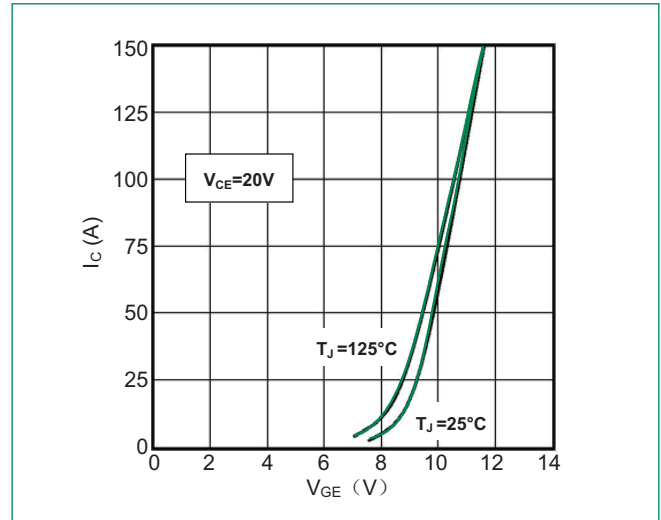


Figure 3: Switching Energy vs. Collector Current

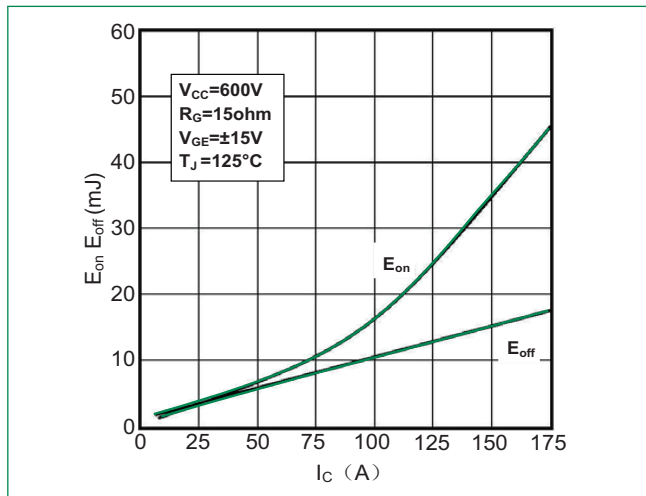


Figure 4: Switching Energy vs. Gate Resistor

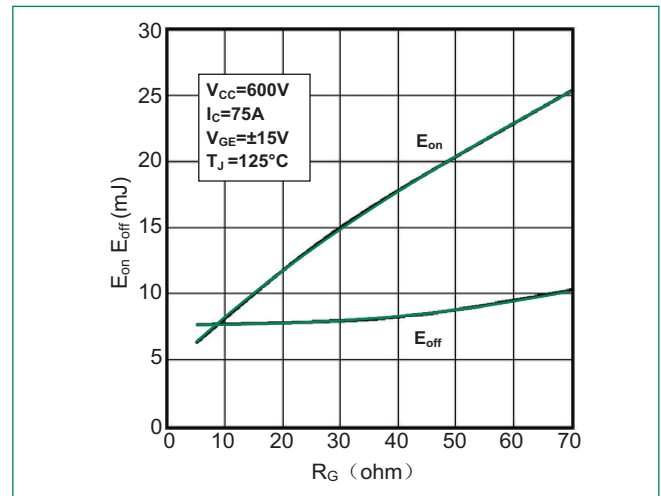


Figure 5: Switching Times vs. Collector Current

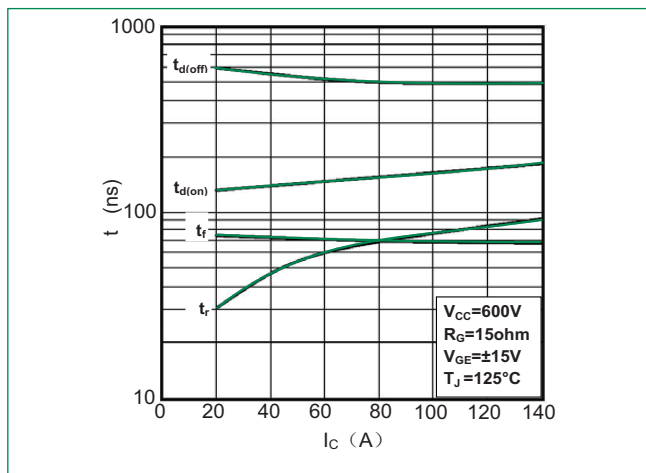


Figure 6: Switching Times vs. Gate Resistor

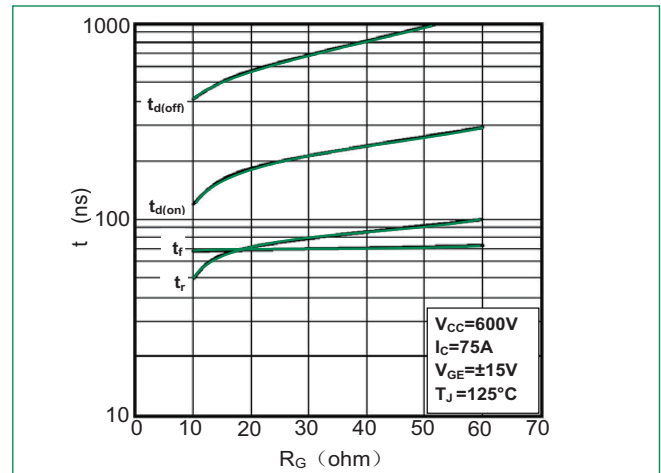


Figure 7: Gate Charge characteristics

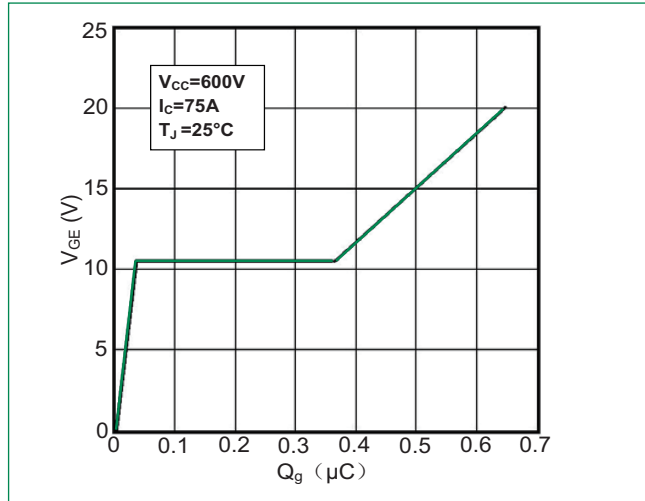


Figure 8: Typical Capacitances vs. V_{CE}

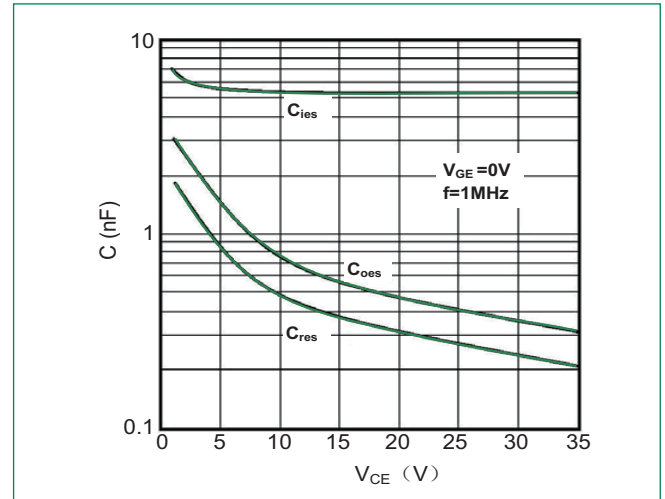


Figure 9: Reverse Biased Safe Operating Area

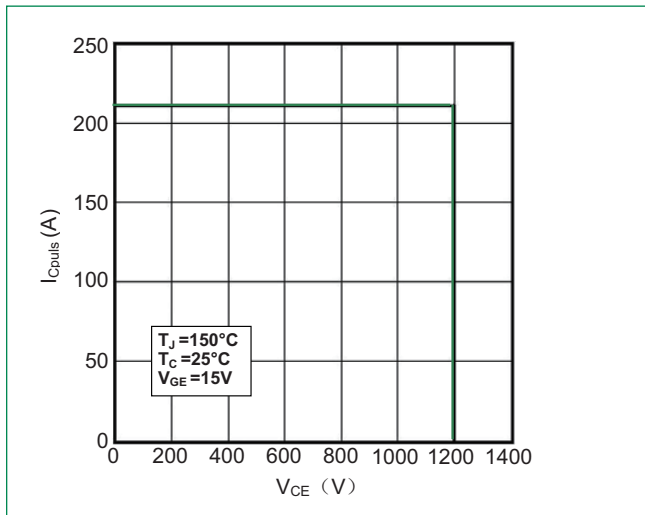


Figure 10: Short Circuit Safe Operating Area

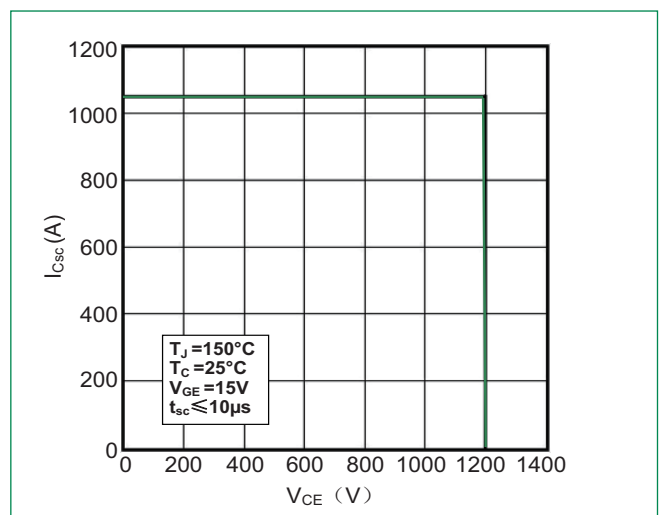


Figure 11: Rated Current vs. T_C

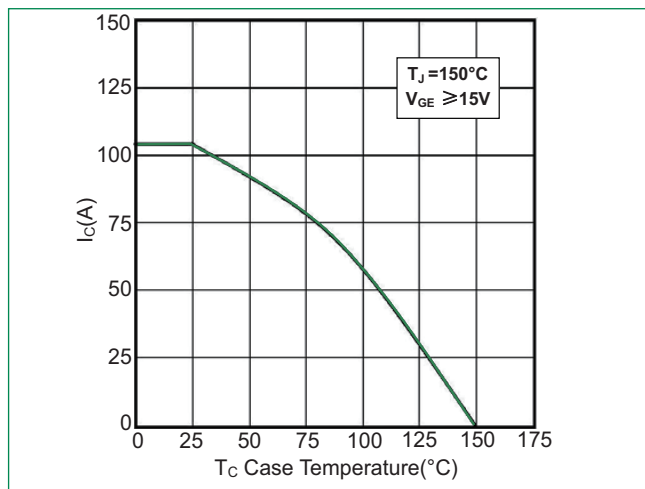


Figure 12: Diode Forward Characteristics

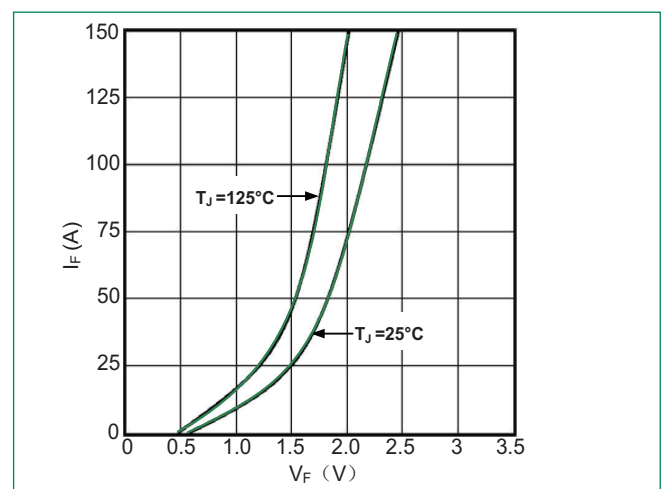


Figure 13: Transient Thermal Impedance of IGBT

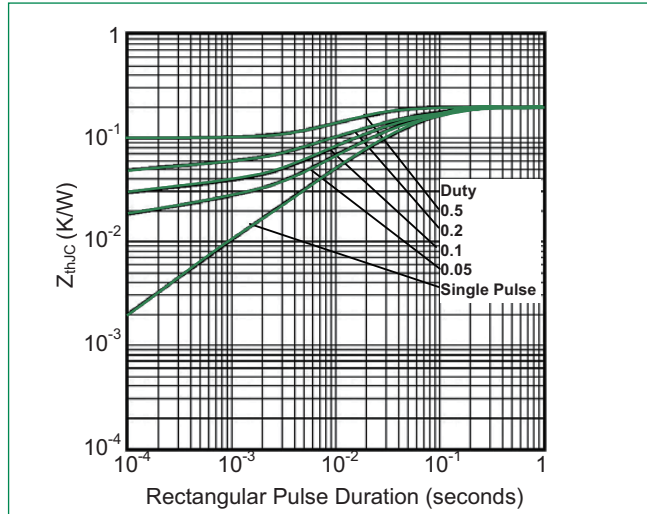
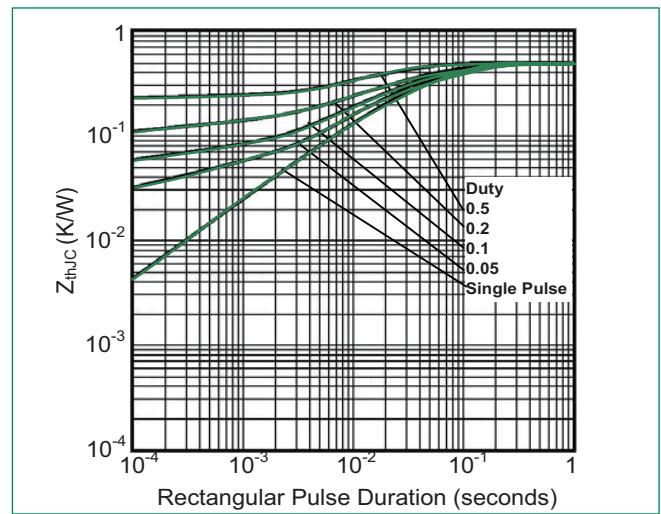
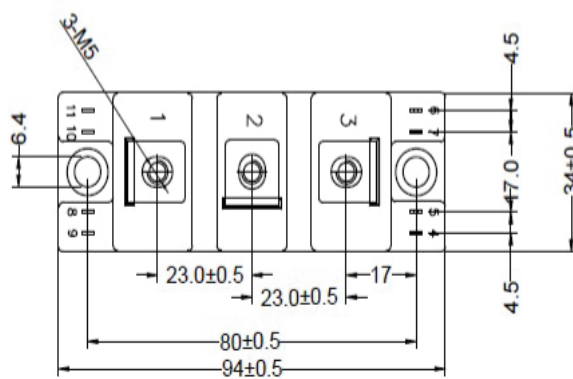
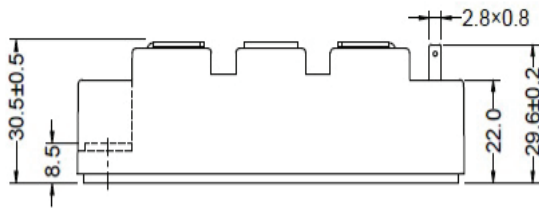


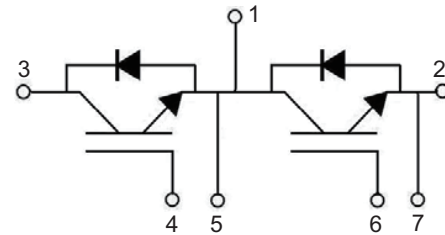
Figure 14: Transient Thermal Impedance of Diode



Dimensions-Package S



Circuit Diagram



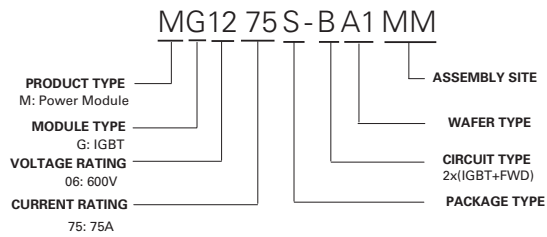
Power Module

1200V 75A IGBT Module

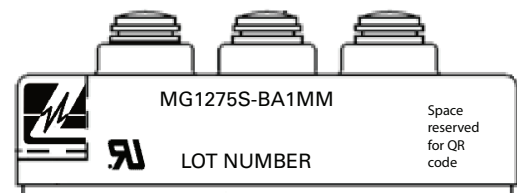
Packing Options

Part Number	Marking	Weight	Packing Mode	M.O.Q
MG1275S-BA1MM	MG1275S-BA1MM	150g	Bulk Pack	100

Part Numbering System



Part Marking System



AMEYA360

Components Supply Platform

Authorized Distribution Brand :



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